

DATA SHEET

CURRENT SENSOR-LOW TCR

PE1206-series

5%,1%

size 1206

RoHS Compliant & Halogen Free



YAGEO Phicomp



SCOPE

This specification describes PE1206 current sensor - low TCR chip resistors with lead-free terminations.

APPLICATIONS

- Power supplies
- Consumer(Mobile \ PNDs \ ...)
- Laptop
- HDDs

FEATURES

- Products with lead free terminations meet RoHS requirements.
- High component and equipment reliability with high power rating.
- Low resistance and narrow tolerance can suitable for current detection.
- Low thermal EMF(<1uV/°C).
- Low inductance <0.5uH (10MHz).

ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient of resistance, taping reel, resistance value.

<u>X</u> <u>X</u> XX XXXX Ζ **PE1206** (6)(1) (2) (3) (4) (5)

(1) TOLERANCE

 $F = \pm 1\%$

 $J = \pm 5\%$

(2) PACKAGING TYPE

K = Embossed taping reel

(3) TEMPERATURE COEFFICIENT OF RESISTANCE

F= ±100ppm/℃

M= ±75ppm/℃

E= ±50ppm/℃

(4) TAPING REEL

07 = 7 inch dia. Reel & Power Rating 0.25W

7W = 7 inch dia. Reel & Power Rating 0.5W

47 = 7 inch dia. Reel & Power Rating 1W

(5) RESISTANCE VALUE

 $0R003 (3m \Omega) \sim 0R3 (300m \Omega)$

(6) DEFAULT CODE

Letter Z is system default code for order only (NOTE)

ORDERING EXAMPLE

The ordering code for a PE1206 1W chip resistor, TC100 value $0.01\Omega(10m\Omega)$ with ±1% tolerance, supplied in 7-inch tape reel with 4Kpcs quantify is:

PE1206FKF470R01Z.

NOTE

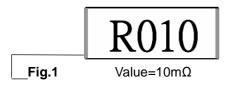
- 1. All our RSMD products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process".
- 2. On customized label, "LFP" or specific symbol can be printed.

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MARKING

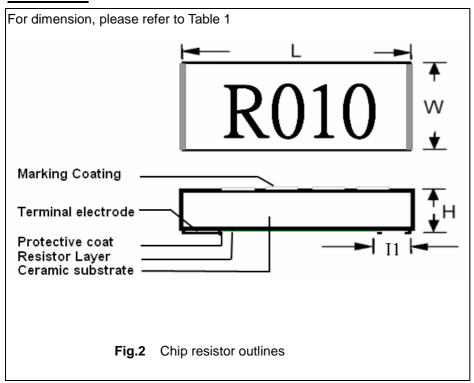
PE1206



4 digits

The "R" is used as a decimal point; the other 3 digits are significant.

OUTLINES



DIMENSIONS

Table 1	
TYPE	PE1206
L (mm)	3.20±0.20
W (mm)	1.60±0.20
H (mm)	0.60±0.15
I1 (mm) - 3mΩ	1.30±0.20
I1 (mm) - 4mΩ	1.20±0.20
I1 (mm) - $5m\Omega \sim 8 m\Omega$	1.15±0.20
I1 (mm) - \geq 9 m Ω	0.58±0.20

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ELECTRICAL CHARACTERISTICS



CHARACTERISTICS

Operating Temperature Range	–55℃ to +155℃
Maximum Working Voltage	$\sqrt{(P*R)}$
Resistance Range	3 m Ω ~ 300 m Ω
Temperature Coefficient	±100ppm/℃
	±75ppm/℃
	±50ppm/℃

PACKING STYLE AND PACKAGING QUANTITY

Table 3

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
PE1206	Embossed taping reel	7" (178 mm)	4,000 Units

FUNCTIONAL DESCRIPTION

POWER RATING

PE1206 rated power at 70℃ is 1/4W, 1/2W & 1W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$U=\sqrt{(P*R)}$$

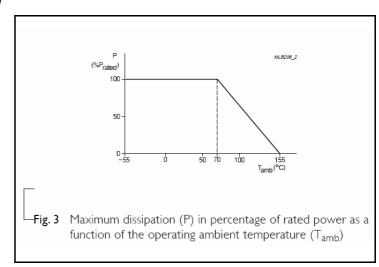
Where

U=Continuous rated DC

or AC (rms) working voltage (v)

P=Rated power

R=Resistance value (Ω)





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TAPING REEL

_ Table 4

I .	
DIMENSION	1206
Tape Width(mm)	8
ØA (mm)	178.0±5
ØN (mm)	60.0±2
ØC (mm)	13.50±0.5
ØD (mm)	21.0±0.8
W1 (mm)	8.4 +1/-0
W2 (mm)	Max 12.4

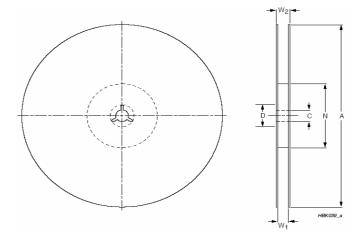


Fig.4 Reel

TAPE SPECIFICATION

Table 5	
DIMENSION	1206
A_0 (mm)	1.82±0.15
B ₀ (mm)	3.53±0.15
W (mm)	8.00±0.30
E (mm)	1.75±0.10
F (mm)	3.50±0.10
P ₀ (mm)	4.00±0.10
P ₁ (mm)	4.00±0.10
P ₂ (mm)	2.00±0.10
D ₀ (mm)	1.50±0.10
D_1 (mm)	1.50±0.10
T (mm)	0.85±0.15

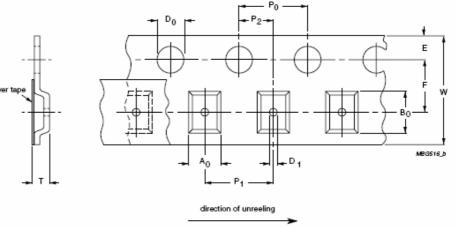


Fig.5 Embossed taping reel

PACKING METHOD

LEADER/TRAILER TAPE SPECIFICATION

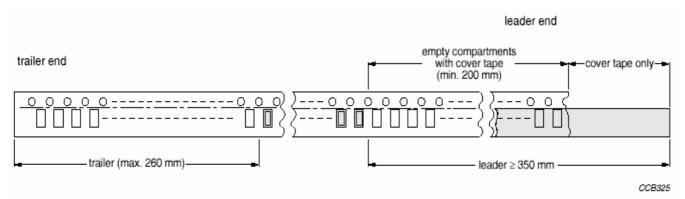


Fig.6 Leader/trailer tape

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RECOMMENDED FOOTPRINT DIMENSIONS

FOOTPRINT DIMENSION

Size Footprint	Dime	nsions	Code	unit :	mm
PE1206	Α	В		С	D
3mR	6.2	0.4		2.9	1.84
4mR	6.2	0.5		2.85	1.84
5mR~8mR	6.2	0.6		2.8	1.84
≧9mR	6.2	1.2		2.5	1.84

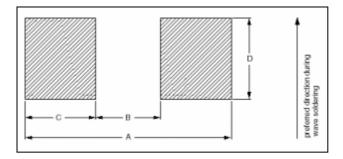


Fig.7 RECOMMENDED FOOTPRINT DIMENSIONS

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TESTS AND REQUIREMENTS

TEST	TEST METHOD	PROCEDURE	REQUIREMENT
Life/ Endurance	IEC 60115-1 4.25.1	1,000 hours at 70±5 ℃ applied RCWV 1.5 hours on, 0.5 hour off, still air required	$\pm (1.0 \% + 0.0005 \Omega)$
High Temperature Exposure/ Endurance at upper category temperature	IEC 60068-2-2	1,000 hours at 155±5 ℃,unpowered	$\pm (1.0 \% + 0.0005 \Omega)$
Moisture Resistance	MIL-STD-202 Method 106G	Each temperature / humidity cycle is defined at 8 hours (Method 106G), 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, un-powered Parts mounted on test-boards, without condensation on parts Measurement at 24±2 hours after test conclusion.	$\pm (0.5\% + 0.0005 \Omega)$
Thermal Shock	MIL-STD-202 Method 107G	-55/+125 ℃ Note: Number of cycles required is 300. Devices unmounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	$\pm (1.0\% + 0.0005 \Omega)$
Short time overload	IEC 60115-1 4.13	Applied 5 times of rating power 5 seconds at room temperature	$\pm (0.5\% + 0.0005 \Omega)$ No visible damage
Board Flex/ Bending	IEC 60068-2-21	Chips mounted on a 90mm glass epoxy resin PCB(FR4) 2 mm bending Bending time: 60±1 seconds	$\pm (1.0 \% + 0.0005 \Omega)$
Solderability - Wetting	IPC/JEDEC J-STD-002B test B	Electrical Test not required Magnification 50X SMD conditions: 1st step: Method B, aging 4 hours at 155 °C dry heat 2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds	Well tinned (≥95% covered) No visible damage
- Leaching	IPC/JEDEC J-STD-002B test D	Leadfree solder, 260 ℃, 30 seconds immersion time	No visible damage
- Resistance to Soldering Heat	IEC 60068-2-58	Condition B, no pre-heat of samples Leadfree solder, 260±5 °C, 10±1seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	\pm (0.5% + 0.0005 Ω) No visible damage

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	Chip Resistor S	Surface Mount PE SERIES	1206	6
REVISION	HISTORY	1	l	
REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION	
Version 0	2010-08-18		- First issue of this specification	
Version 1	2010-11-11		- Change Quantity Per Reel from 5Kpcs to 4Kpcs	
Version 2	2011-09-01		- Range extension to 300m Ω	